



- NOTE
- MATERIAL
    - HEADER : LIQUID CRYSTAL POLYMER(LCP) UL94V-0, HALOGEN FREE, COLOR OF NATURAL
    - CONTACT TERMINAL : COPPER-ALLOY, 0.3mm THICKNESS
  - PLATING
    - CONTACT TERMINAL : TIN -PLATED
    - 1.0μm MINIMUM TIN PLATING
  - PRODUCT SPECIFICATION : PS-104188-001
  - PACKAGING SPECIFICATION : PK-104188-001
  - COPLANALITY OF SOLDER TAILS (PEAK TEMP. : 260°C), BEFORE & AFTER REFLOW : 0.08 MAX.
  - APPLICABLE SOLID WIRE RANGE : AWG 24~18 (OUTSIDE WIRE INSULATION : 2.1mm DIAMETER MAX.)

PRE-RELEASE  
REFERENCE  
USE ONLY



194214, .71  
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: (+7 812) 324-66-11  
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QUALITY SYMBOLS ▽=0 ∇=0	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY	SCALE 7/1	DESIGN UNITS METRIC	THIRD ANGLE PROJECTION
		mm INCH				
DESCRIPTION PRELIMINARY EC NO: DRWN: JSSHIN CHKD: APPR:	4 PLACES	±	±	DRAWN BY JS.SHIN	DATE 2013/08/29	TITLE S-POKE CONNECTOR HEADER ASS'Y -2P
	3 PLACES	±	±	CHECKED BY SH.CHU	DATE 2013/08/29	
	2 PLACES	± 0.15	±	APPROVED BY	DATE	molex
	1 PLACE	± 0.20	±	YS00.KIM	2013/08/29	
	0 PLACE	±	±	MATERIAL NO. 1041880210	DOCUMENT NO. SD-104188-003	
REV 1	ANGULAR ± 1 ° DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		SIZE A3	THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION		